MOSFETs Silicon N-Channel MOS (DTMOSVI)

TK040N60Z1

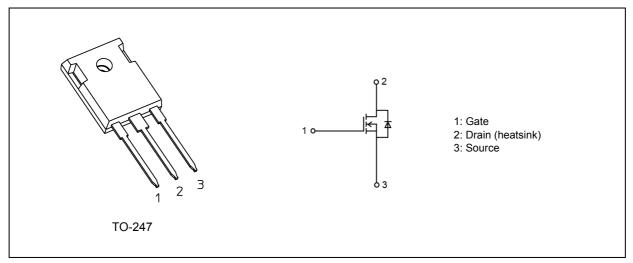
1. Applications

• Switching Power Supplies

2. Features

- (1) Low drain-source on-resistance: $R_{DS(ON)} = 0.033 \Omega$ (typ.)
- (2) High-speed switching properties with lower capacitance.
- (3) Enhancement mode: V_{th} = 3 to 4 V (V_{DS} = 10 V, I_D = 2.4 mA)

3. Packaging and Internal Circuit



4. Absolute Maximum Ratings (Note) (T_a = 25 °C unless otherwise specified)

Characteristics	Symbol	Rating	Unit	
Drain-source voltage		V _{DSS}	600	V
Gate-source voltage		V _{GSS}	±30	
Drain current (DC)	(Note 1)	Ι _D	52	A
Drain current (pulsed)	(Note 1)	I _{DP}	208	
Power dissipation $(T_c = 25 \text{ °C})$		PD	297	W
Single-pulse avalanche energy	(Note 2)	E _{AS}	1049	mJ
Single-pulse avalanche current		I _{AS}	8.0	A
Reverse drain current (DC)	(Note 1)	I _{DR}	52	
Reverse drain current (pulsed)	(Note 1)	I _{DRP}	208	
Channel temperature		T _{ch}	150	°C
Storage temperature		T _{stg}	-55 to 150	
Mounting torque		TOR	0.8	N · m

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Start of commercial production 2024-06

5. Thermal Characteristics

Characteristics	Symbol	Max	Unit
Channel-to-case thermal resistance	R _{th(ch-c)}	0.420	°C/W
Channel-to-ambient thermal resistance	R _{th(ch-a)}	50	

Note 1: Ensure that the channel temperature does not exceed 150 °C. Note 2: V_{DD} = 90 V, T_{ch} = 25 °C (initial), L = 29 mH, I_{AS} = 8.0 A

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

6. Electrical Characteristics

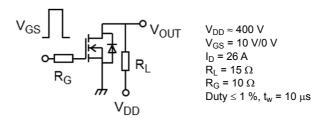
6.1. Static Characteristics ($T_a = 25$ °C unless otherwise specified)

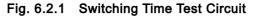
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I _{GSS}	V_{GS} = ±30 V, V_{DS} = 0 V	_	_	±1	μA
Drain cut-off current	I _{DSS}	V_{DS} = 600 V, V_{GS} = 0 V	_	—	2	
Drain-source breakdown voltage	V _{(BR)DSS}	I _D = 10 mA, V _{GS} = 0 V	600	—	—	V
Gate threshold voltage	V _{th}	V _{DS} = 10 V, I _D = 2.4 mA	3	_	4	
Drain-source on-resistance	R _{DS(ON)}	V _{GS} = 10 V, I _D = 21.2 A		0.033	0.040	Ω

6.2. Dynamic Characteristics ($T_a = 25$ °C unless otherwise specified)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance		C _{iss}	V _{DS} = 300 V, V _{GS} = 0 V, f = 100 kHz	_	5200	_	pF
Reverse transfer capacitance		C _{rss}]	_	4.0	_	
Output capacitance		C _{oss}]	_	120	_	
Effective output capacitance (energy related)	(Note 3)	C _{o(er)}	V_{DS} = 0 to 400 V, V_{GS} = 0 V	—	200	—	
Effective output capacitance (time related)	(Note4)	C _{o(tr)}	V_{DS} = 0 to 400 V, V_{GS} = 0 V	—	1450	—	
Gate resistance		rg	V _{DS} = OPEN , f = 1 MHz	_	2.4	_	Ω
Switching time (rise time)		t _r	See Fig.6.2.1		75	_	ns
Switching time (turn-on time)		t _{on}]	_	120	_	
Switching time (fall time)		t _f]		5	_	
Switching time (turn-off time)		t _{off}	1	_	150	_	
MOSFET dv/dt ruggedness		dv/dt	$V_{DS} \leq V_{DSS}, \ I_D \leq 26 \ A$	120	_	_	V/ns

Note 3: $C_{O(er)}$ is a fixed capacitance that gives the same stored energy as C_{OSS} while V_{DS} is rising from 0 V to 400 V. Note4: $C_{O(tr)}$ is a fixed capacitance that gives the same charging time as C_{OSS} while V_{DS} is rising from 0 V to 400 V.





6.3. Gate Charge Characteristics ($T_a = 25$ °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Qg	$V_{DD} \approx 400$ V, V_{GS} = 10 V, I_{D} = 52 A	—	85	—	nC
Gate-source charge 1	Q _{gs1}		_	29	_	
Gate-drain charge	Q _{gd}		_	22		

6.4. Source-Drain Characteristics ($T_a = 25$ °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Diode forward voltage	V _{DSF}	I _{DR} = 52 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	V _{DD} = 400 V,	_	380	_	ns
Reverse recovery charge	Q _{rr}	I _{DR} = 26 A, V _{GS} = 0 V -dI _{DR} /dt = 100 A/μs	_	6.7	_	μC
Peak reverse recovery current	I _{rr}	$-di_{DR}/dt = 100 A/\mu s$	_	35	_	А
Diode dv/dt ruggedness	dv/dt	$V_{DD} \leq 400$ V, $I_{DR} \leq 26$ A, V_{GS} = 0 V	50		_	V/ns

7. Marking (Note)

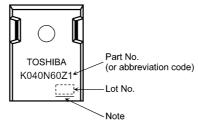


Fig. 7.1 Marking

Note: A line under a Lot No. identifies the indication of product Labels.

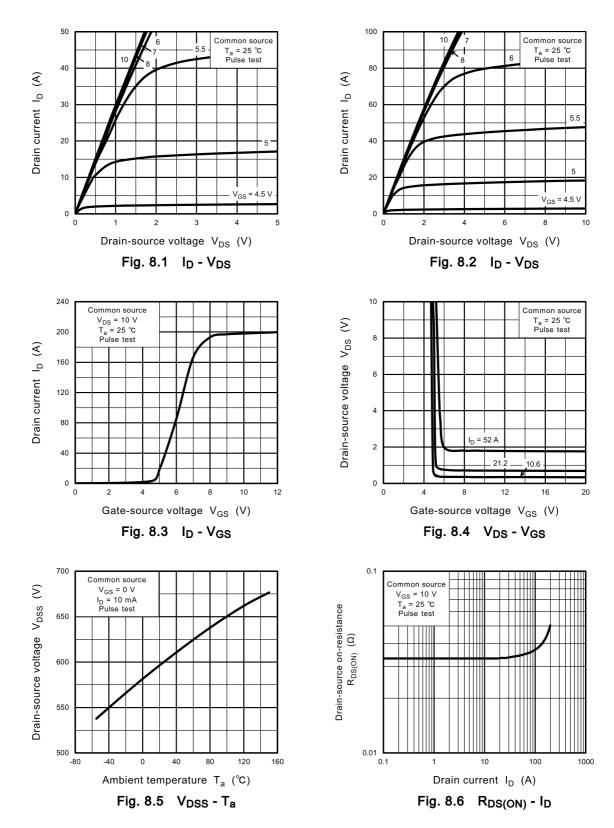
Not underlined: [[Pb]]/INCLUDES > MCV

Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

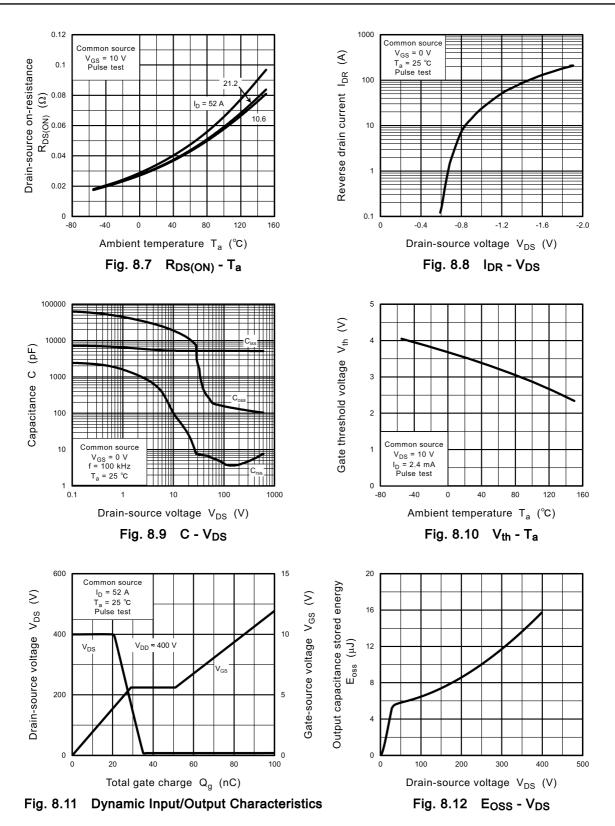
Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.

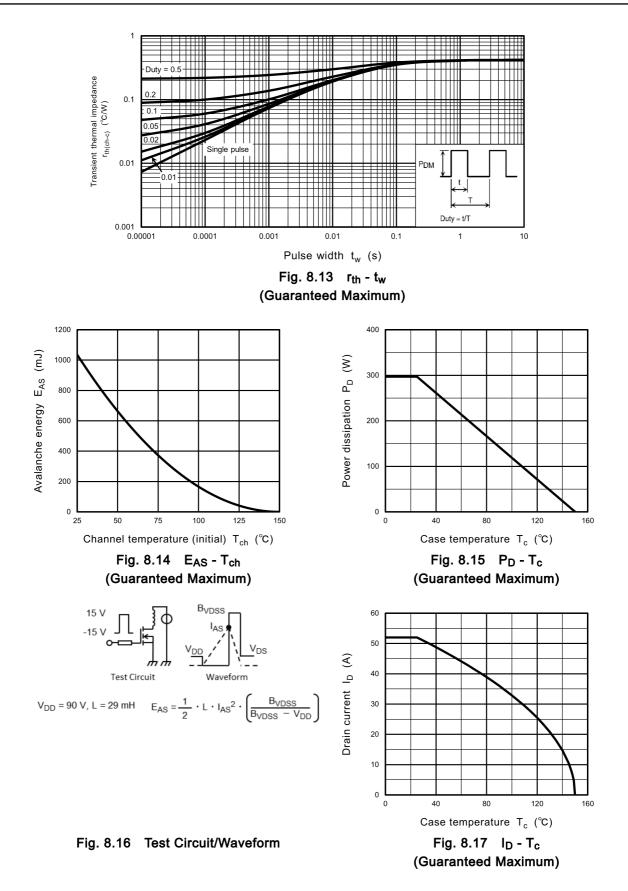
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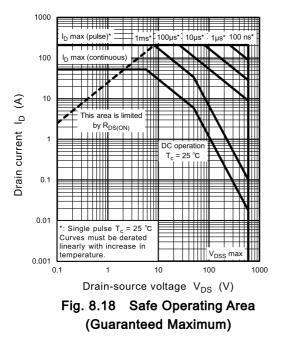
8. Characteristics Curves (Note)









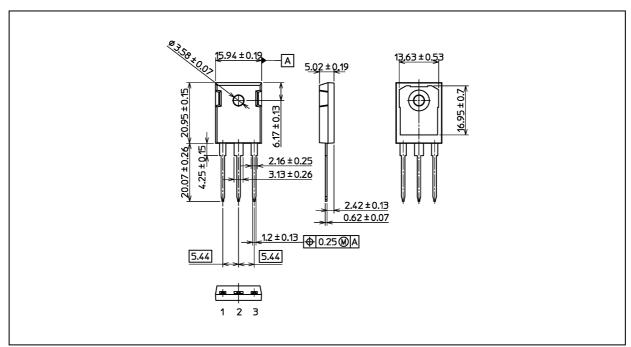


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

TK040N60Z1

Package Dimensions

Unit: mm



Weight: 6.15 g (typ.)

	Package Name(s)
TOSHIBA: 2-16L1A	
Nickname: TO-247	

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